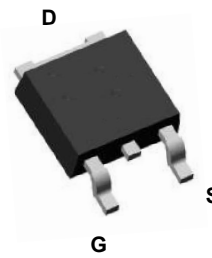
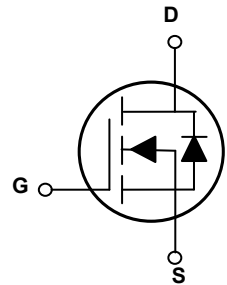


Main Product Characteristics

$V_{(BR)DSS}$	600V
$R_{DS(ON)}$	0.57Ω (Max.)
I_D	7A



TO-252 (DPAK)



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFD6008 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	600	V
Gate to Source Voltage	V_{GS}	±30	V
Drain Current-Continuous, @ Steady-State ($T_C=25^\circ\text{C}$)	I_D	7	A
Drain Current-Continuous, @ Steady-State ($T_C=100^\circ\text{C}$)		4.4	
Pulsed Drain Current	I_{DM}	28	A
Power Dissipation ($T_C=25^\circ\text{C}$)	P_D	60	W
		0.48	W/°C
Single Pulse Avalanche Energy ¹	E_{AS}	248	mJ
Body Diode Reverse Voltage Slope ²	dv/dt	50	V/ns
MOS dv/dt Ruggedness ³	dv/dt	100	V/ns
Junction-to-Ambient (PCB Mounted, Steady-State)	$R_{\theta JA}$	62.0	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	2.08	°C/W
Junction Temperature Range	T_J	-55 To +150	°C
Storage Temperature Range	T_{STG}	-55 To +150	°C

Electrical Characteristics ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On / Off Characteristics						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0V, I_D=250\mu A$	600	-	-	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=600V, V_{GS}=0V$	-	-	200	nA
Gate-Source Forward Leakage	I_{GSS}	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	± 100	nA
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=3.5A, T_J=25^\circ\text{C}$	-	0.48	0.57	Ω
		$V_{GS}=10V, I_D=3.5A, T_J=125^\circ\text{C}$	-	0.95	-	Ω
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=250\mu A$	2	-	4	V
Gate Resistance	R_g	$F=1\text{MHz}$	-	5	-	Ω
Dynamic and Switching Characteristics						
Total Gate Charge ^{4,5}	Q_g	$V_{DD}=480V, I_D=7A, V_{GS}=10V$	-	19	-	nC
Gate-Source Charge ^{4,5}	Q_{gs}		-	5.1	-	
Gate-to-Drain ("Miller") Charge ^{4,5}	Q_{gd}		-	8.6	-	
Turn-On Delay Time ^{4,5}	$t_{d(on)}$	$V_{DD}=300V, R_G=25\Omega, V_{GS}=10V, I_D=7A$	-	20	-	nS
Rise Time ^{4,5}	t_r		-	40	-	
Turn-Off Delay Time ^{4,5}	$t_{d(off)}$		-	91	-	
Fall Time ^{4,5}	t_f		-	38	-	
Input Capacitance	C_{iss}	$V_{DS}=100V, V_{GS}=0V, F=1\text{MHz}$	-	602	-	pF
Output Capacitance	C_{oss}		-	25	-	
Reverse Transfer Capacitance	C_{rss}		-	0.8	-	
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current (Body Diode)	I_S	$T_C=25^\circ\text{C}$, MOSFET symbol showing the integral reverse p-n junction diode.	-	-	7	A
Source Pulse Current	I_{SM}		-	-	28	A
Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=7A$	-	-	1.4	V
Reverse Recovery Time ³	T_{rr}	$I_F=7A, V_{GS}=0V, di_F/dt=100A/\mu s$	-	240	-	nS
Reverse Recovery Charge ³	Q_{rr}		-	2.4	-	μC

Note:

1. $L=79\text{mH}, I_{AS}=2.3A, V_{DD}=100V$, starting temperature $T_J=25^\circ\text{C}$.
2. $V_{DS}=0-400V, I_{SD} \leq 20A, T_J=25^\circ\text{C}$.
3. $V_{DS}=0-480V$.
4. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
5. Essentially independent of operating temperature.

Typical Electrical and Thermal Characteristic Curves

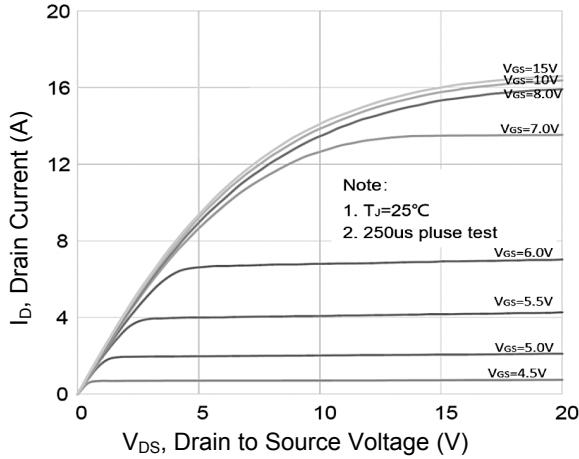


Figure 1. Typical Output Characteristics

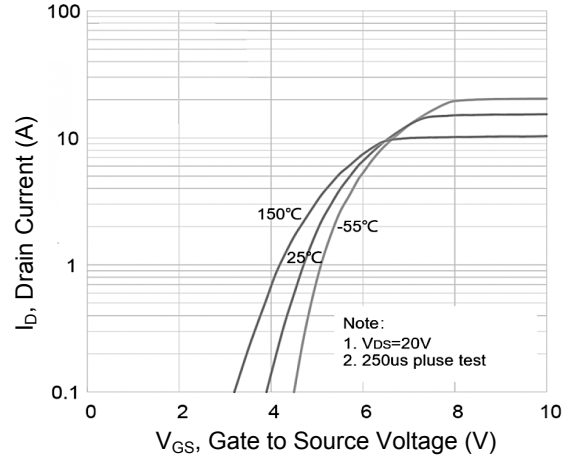


Figure 2. Transfer Characteristics

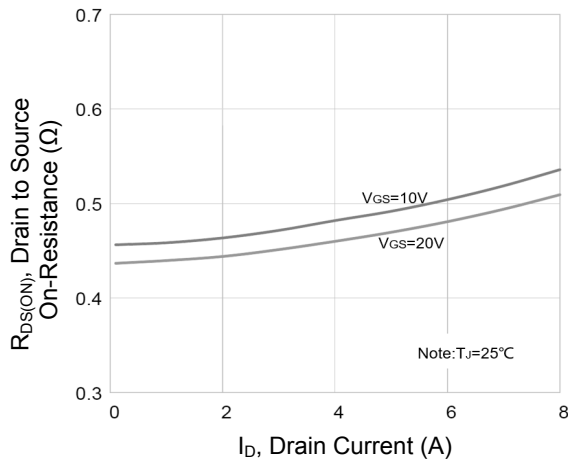


Figure 3. $R_{DS(ON)}$ vs. Drain Current

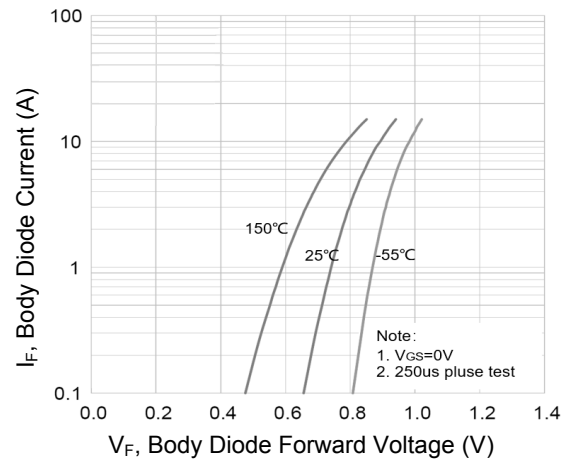


Figure 4. Body Diode Characteristic

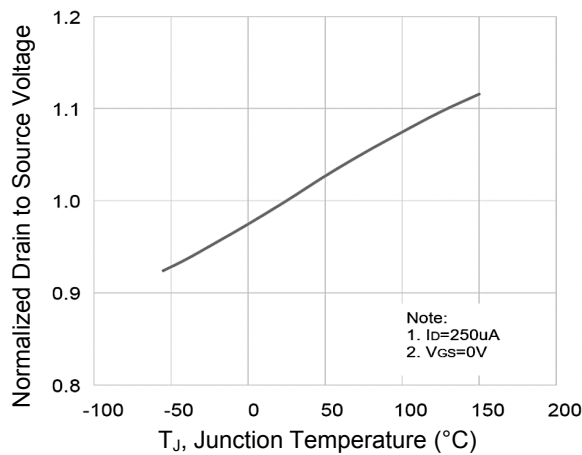


Figure 5. Normalized BV_{DSS} vs. T_J

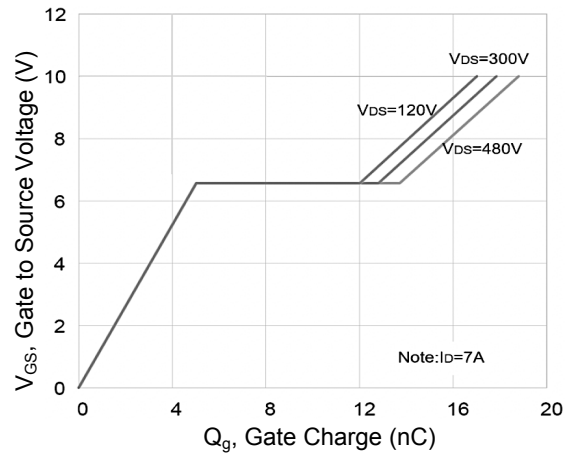


Figure 6. Gate Charge

Typical Electrical and Thermal Characteristic Curves

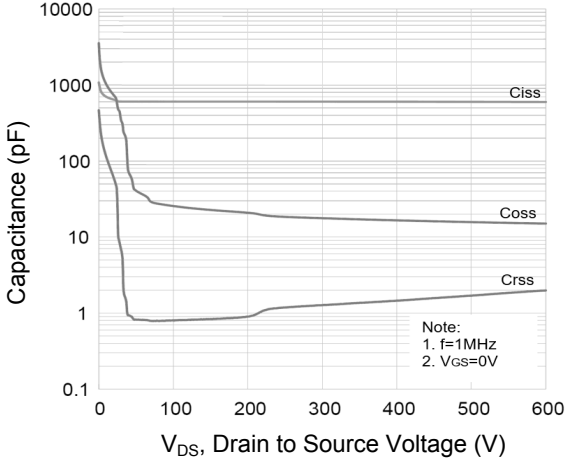


Figure 7. Capacitance Characteristic

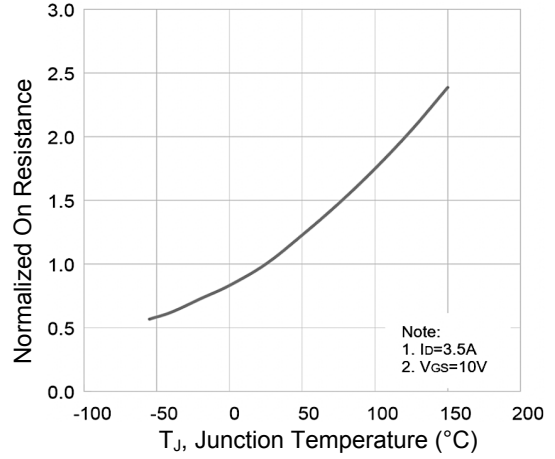


Figure 8. Normalized $R_{DS(ON)}$ vs. T_J

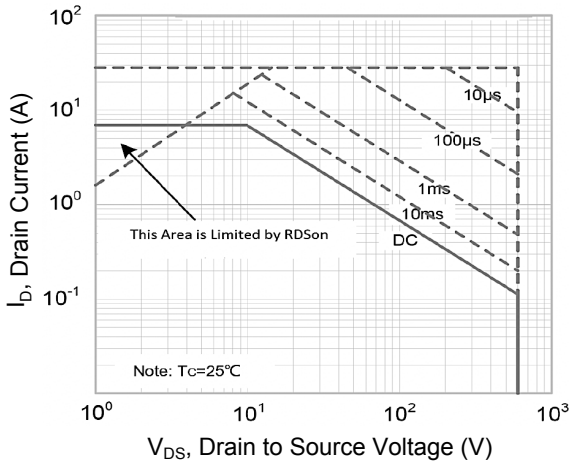
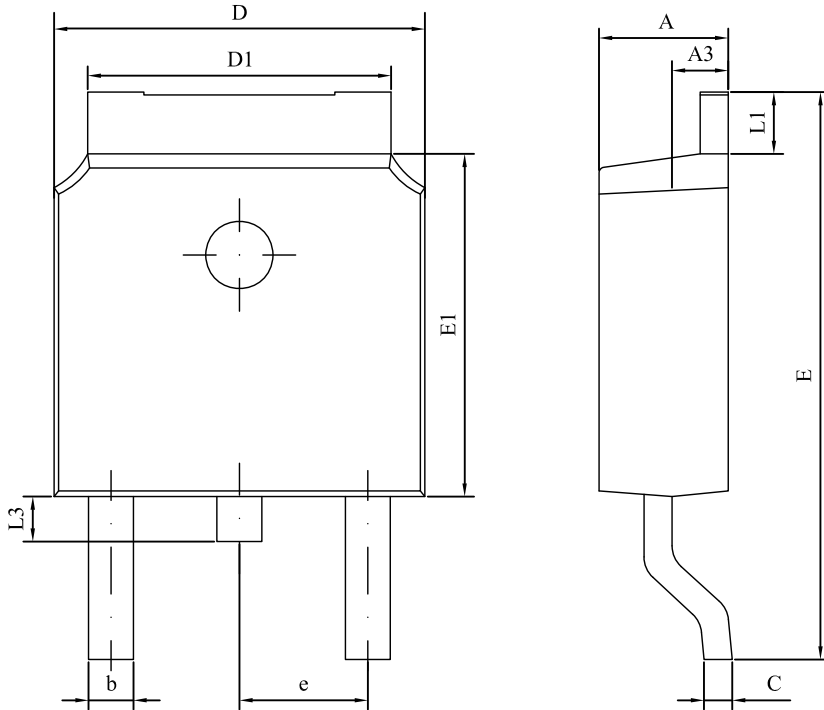


Figure 9. Safe Operation Area

Package Outline Dimensions TO-252 (DPAK)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	2.15	2.40	0.085	0.094
A3	0.90	1.10	0.035	0.043
b	0.50	0.90	0.020	0.035
C	0.40	0.65	0.016	0.026
D	6.30	6.90	0.248	0.272
D1	4.95	5.50	0.195	0.217
E	9.40	10.41	0.370	0.410
E1	5.90	6.30	0.232	0.248
e	2.286 BSC		0.090 BSC	
L1	0.89	1.27	0.035	0.050
L3	0.60	1.10	0.024	0.043

Order Information

Device	Package	Marking	Carrier	Quantity
GSFD6008	TO-252 (DPAK)	D60R570	Tape & Reel	2,500 Pcs / Reel

For more information, please contact us at: inquiry@goodarksemi.com